

# DATA SHEET



**BYD167**

Ultra fast low-loss rectifier

Product specification  
Supersedes data of 1999 Feb 10

1999 Nov 11

## Ultra fast low-loss rectifier

## BYD167

## FEATURES

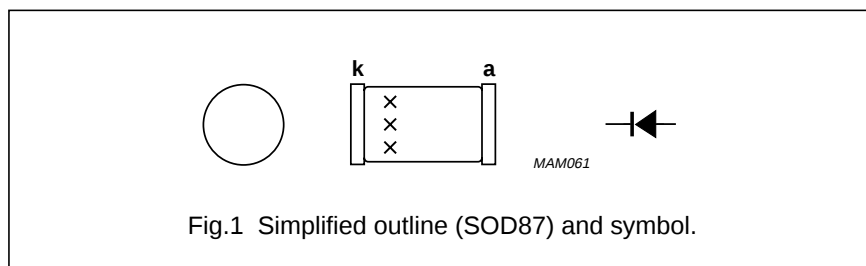
- Glass passivated
- High maximum operating temperature
- Low leakage current
- Excellent stability
- Available in ammo-pack
- Smallest surface mount rectifier package.

## DESCRIPTION

Cavity free cylindrical glass SOD87 package through Implotec™<sup>(1)</sup> technology. The SOD87 package is

hermetically sealed and fatigue free as coefficients of expansion of all used parts are matched.

(1) Implotec is a trademark of Philips.



## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL      | PARAMETER                           | CONDITIONS                                                                  | MIN. | MAX. | UNIT |
|-------------|-------------------------------------|-----------------------------------------------------------------------------|------|------|------|
| $V_{RRM}$   | repetitive peak reverse voltage     |                                                                             | —    | 600  | V    |
| $V_R$       | continuous reverse voltage          |                                                                             | —    | 600  | V    |
| $I_{F(AV)}$ | average forward current             | $T_{tp} = 135\text{ °C}$ ; averaged over any 20 ms period; see Figs 5 and 6 | —    | 1    | A    |
|             |                                     | $T_{tp} = 70\text{ °C}$ ; averaged over any 20 ms period; see Figs 5 and 6  | —    | 2    | A    |
| $I_{FSM}$   | non-repetitive peak forward current | $t = 10\text{ ms}$ half sinewave;<br>$V_R = V_{RRMmax}$                     | —    | 25   | A    |
| $T_{stg}$   | storage temperature                 |                                                                             | −65  | +175 | °C   |
| $T_j$       | junction temperature                |                                                                             | −65  | +175 | °C   |

## ELECTRICAL CHARACTERISTICS

$T_j = 25\text{ °C}$  unless otherwise specified.

| SYMBOL   | PARAMETER             | CONDITIONS                                                                                           | MAX. | UNIT |
|----------|-----------------------|------------------------------------------------------------------------------------------------------|------|------|
| $V_F$    | forward voltage       | $I_F = 1\text{ A}$ ; $T_j = 150\text{ °C}$ ; see Fig.2                                               | 1.05 | V    |
|          |                       | $I_F = 1\text{ A}$ ; see Fig.2                                                                       | 1.25 | V    |
| $I_R$    | reverse current       | $V_R = V_{RRMmax}$ ; see Fig.3                                                                       | 5    | μA   |
|          |                       | $V_R = V_{RRMmax}$ ; $T_j = 150\text{ °C}$ ; see Fig.3                                               | 150  | μA   |
| $t_{rr}$ | reverse recovery time | when switched from $I_F = 0.5\text{ A}$ to $I_R = 1\text{ A}$ ;<br>measured at $I_R = 0.25\text{ A}$ | 50   | ns   |

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## THERMAL CHARACTERISTICS

| SYMBOL         | PARAMETER                                     | CONDITIONS | VALUE | UNIT |
|----------------|-----------------------------------------------|------------|-------|------|
| $R_{th\ j-tp}$ | thermal resistance from junction to tie-point |            | 30    | K/W  |
| $R_{th\ j-a}$  | thermal resistance from junction to ambient   | note 1     | 150   | K/W  |

## Note

1. Device mounted on epoxy-glass printed-circuit board, 1.5 mm thick; thickness of copper  $\geq 40\ \mu\text{m}$ , see Fig.7.  
For more information please refer to the *"General Part of associated Handbook"*.

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GRAPHICAL DATA

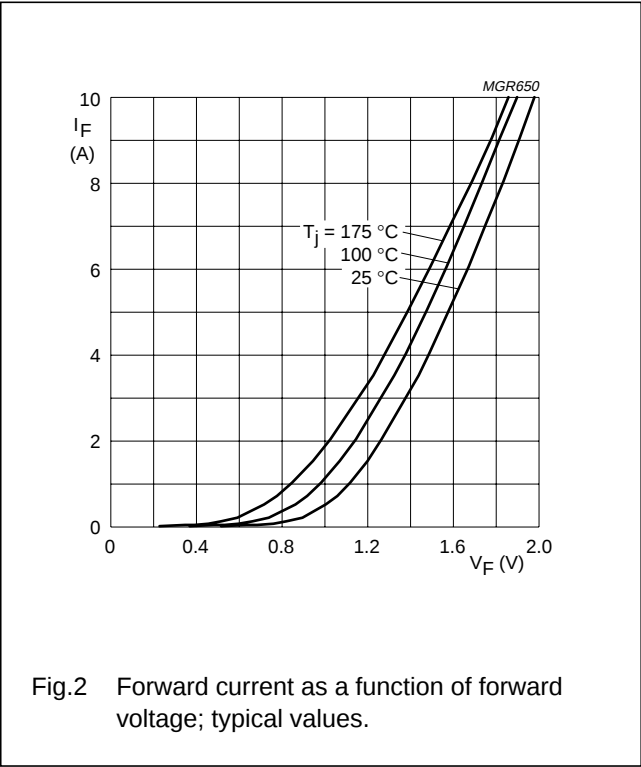


Fig.2 Forward current as a function of forward voltage; typical values.

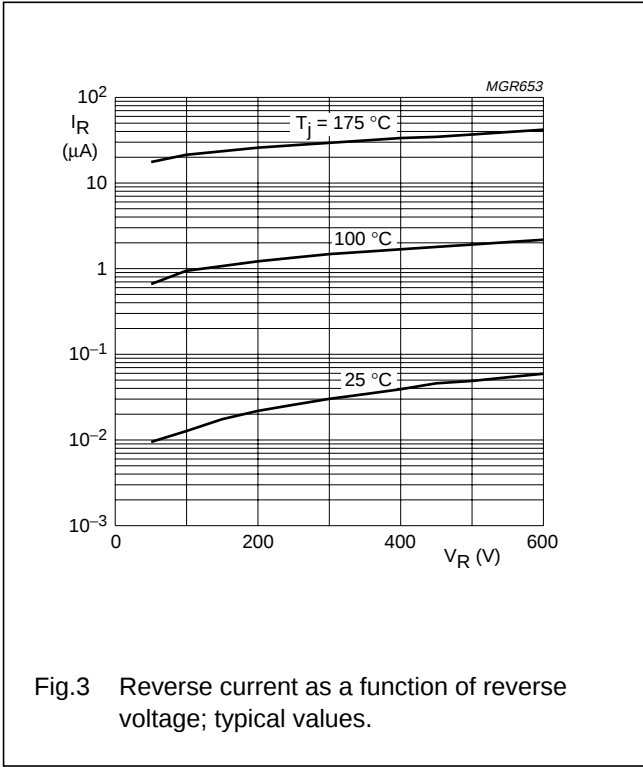


Fig.3 Reverse current as a function of reverse voltage; typical values.

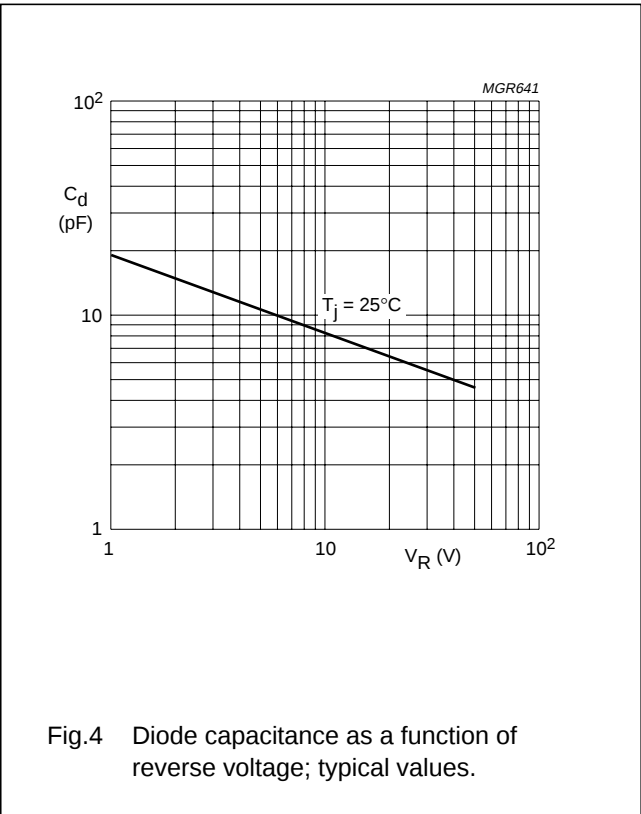


Fig.4 Diode capacitance as a function of reverse voltage; typical values.

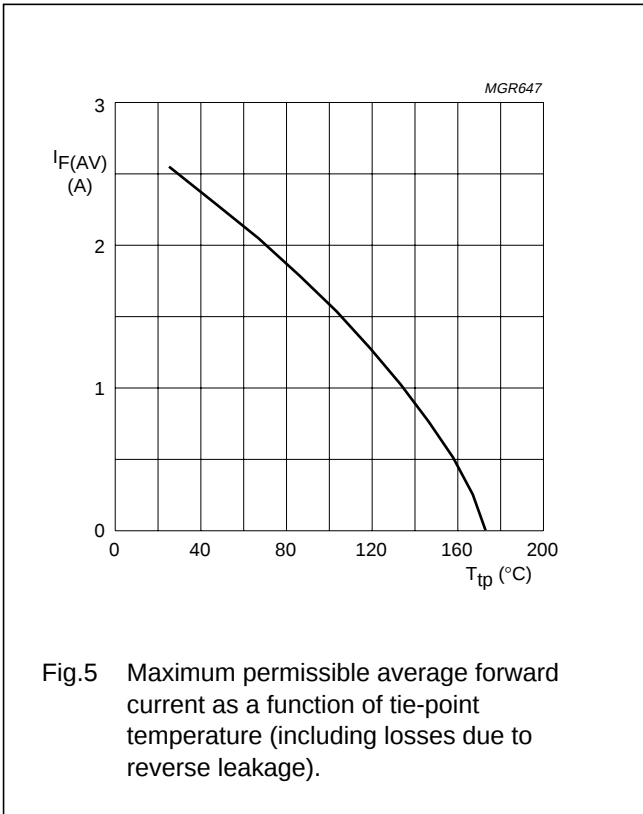


Fig.5 Maximum permissible average forward current as a function of tie-point temperature (including losses due to reverse leakage).

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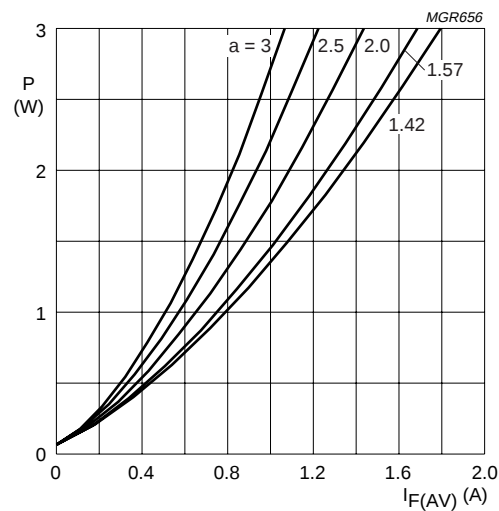
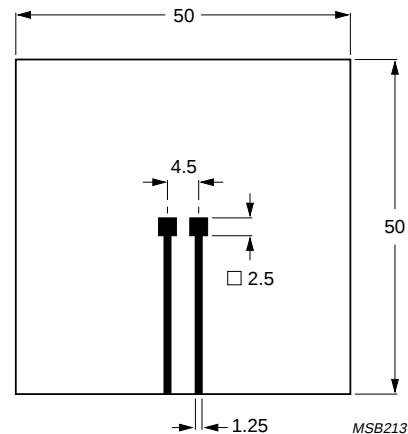


Fig.6 Maximum steady state power dissipation (forward plus leakage current losses, excluding switching losses) as a function of average forward current.



Dimensions in mm.

Fig.7 Printed-circuit board for surface mounting.

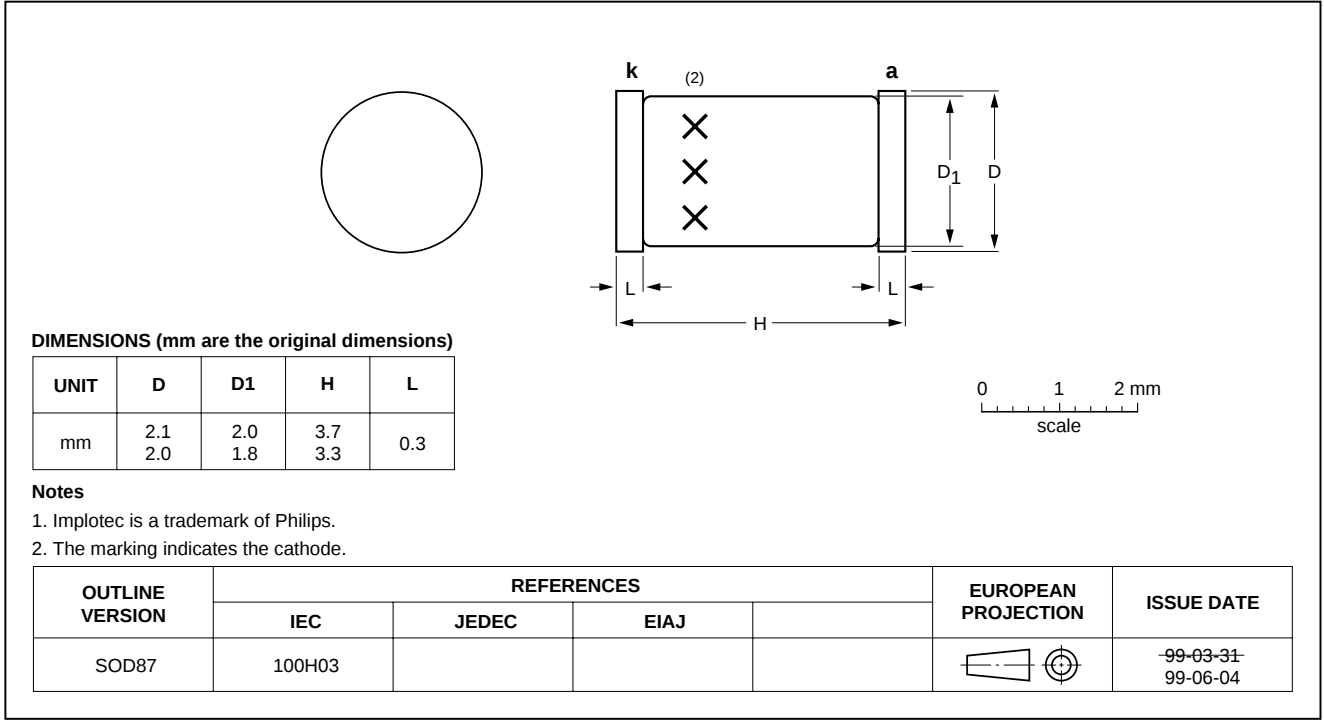
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PACKAGE OUTLINE

Hermetically sealed glass surface mounted package;  
Implotec™<sup>(1)</sup> technology; 2 connectors

SOD87



DEFINITIONS

| Data Sheet Status                                                                                                                                                                                                                                                                                                                                                                                                                                         |                                                                                       |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| Objective specification                                                                                                                                                                                                                                                                                                                                                                                                                                   | This data sheet contains target or goal specifications for product development.       |
| Preliminary specification                                                                                                                                                                                                                                                                                                                                                                                                                                 | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification                                                                                                                                                                                                                                                                                                                                                                                                                                     | This data sheet contains final product specifications.                                |
| Limiting values                                                                                                                                                                                                                                                                                                                                                                                                                                           |                                                                                       |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |                                                                                       |
| Application information                                                                                                                                                                                                                                                                                                                                                                                                                                   |                                                                                       |
| Where application information is given, it is advisory and does not form part of the specification.                                                                                                                                                                                                                                                                                                                                                       |                                                                                       |

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